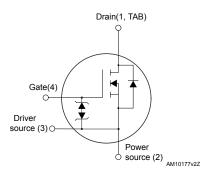


N-channel 600 V, 36 m Ω typ., 62 A, MDmesh DM6 Power MOSFET in a TO247-4 package



TO247-4



Features

Order code	V _{DS}	R _{DS(on)} max.	I _D	
STW70N60DM6-4	600 V	42 mΩ	62 A	

- · Fast-recovery body diode
- Lower R_{DS(on)} per area vs previous generation
- · Low gate charge, input capacitance and resistance
- 100% avalanche tested
- Extremely high dv/dt ruggedness
- Zener-protected
- Excellent switching performance thanks to the extra driving source pin

Applications

· Switching applications

Description

This high-voltage N-channel Power MOSFET is part of the MDmesh DM6 fast-recovery diode series. Compared with the previous MDmesh fast generation, DM6 combines very low recovery charge (Q_{rr}), recovery time (t_{rr}) and excellent improvement in $R_{DS(on)}$ per area with one of the most effective switching behaviors available in the market for the most demanding high-efficiency bridge topologies and ZVS phase-shift converters.



Product status link

STW70N60DM6-4

Product summary			
Order code STW70N60DM6-4			
Marking	70N60DM6		
Package	TO247-4		
Packing	Tube		



1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{GS}	Gate-source voltage	±25	V
I _D	Drain current (continuous) at T _C = 25 °C	62	А
I _D	Drain current (continuous) at T _C = 100 °C	39	А
I _{DM} ⁽¹⁾	Drain current (pulsed)	220	А
P _{TOT}	Total power dissipation at T _C = 25 °C	390	W
dv/dt ⁽²⁾	Peak diode recovery voltage slope	100	V/ns
di/dt ⁽²⁾	Peak diode recovery current slope	1000	A/µs
dv/dt ⁽³⁾	MOSFET dv/dt ruggedness	100	V/ns
T _{stg}	Storage temperature range	55 to 150	°C
TJ	Operating junction temperature range	-55 to 150	°C

- 1. Pulse width is limited by safe operating area.
- 2. $I_{SD} \le 62\,A,\ V_{DS}\ (peak) < V_{(BR)DSS},\ V_{DD} = 400\ V.$
- 3. $V_{DS} \le 480 \text{ V}$.

Table 2. Thermal data

Symbol	Parameter	Value	Unit
R _{thJC}	Thermal resistance, junction-to-case	0.32	°C/W
R _{thJA}	Thermal resistance, junction-to-ambient	50	°C/W

Table 3. Avalanche characteristics

Symbol	Parameter	Value	Unit
I _{AR}	Avalanche current, repetitive or not repetitive (pulse width limited by T _J max)	7	Α
E _{AS}	Single pulse avalanche energy (starting $T_J = 25$ °C, $I_D = I_{AR}$, $V_{DD} = 50$ V)	1850	mJ

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2 Electrical characteristics

 T_C = 25 °C unless otherwise specified

Table 4. On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}$	600			V
1	Zono moto vielto no due in comunit	V _{GS} = 0 V, V _{DS} = 600 V			1	μА
I _{DSS}	Zero gate voltage drain current	V _{GS} = 0 V, V _{DS} = 600 V, T _J = 125 °C ⁽¹⁾			100	
I _{GSS}	Gate-body leakage current	V _{DS} = 0 V, V _{GS} = ±25 V			±5	μA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_{D} = 250 \mu A$	3.25	4	4.75	V
R _{DS(on)}	Static drain-source on-resistance	V _{GS} = 10 V, I _D = 31 A		36	42	mΩ

^{1.} Specified by design, not tested in production.

Table 5. Dynamic characteristics

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss}	Input capacitance		-	4360	-	
C _{oss}	Output capacitance	V _{DS} = 100 V, f = 1 MHz, V _{GS} = 0 V	-	235	-	
C _{rss}	Reverse transfer capacitance		-	13	-	pF
Coss eq. (1)	Equivalent output capacitance	V _{DS} = 0 to 480 V, V _{GS} = 0 V	-	697	-	
R_{G}	Intrinsic gate resistance	f = 1 MHz, I _D = 0 A		1.5	-	Ω
Qg	Total gate charge	V _{DD} = 480 V, I _D = 62 A, V _{GS} = 0 to 10 V	-	99	-	
Q _{gs}	Gate-source charge	(see Figure 14. Test circuit for gate	-	28	-	nC
Q _{gd}	Gate-drain charge	charge behavior)	-	44	-	

^{1.} $C_{\text{oss eq}}$ is defined as a constant equivalent capacitance giving the same charging time as Coss when V_{DS} increases from 0 to 80% V_{DSS}

Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	V _{DD} = 300 V, I _D = 31 A,	-	27	-	ns
t _r	Rise time	$R_G = 4.7 \Omega$, $V_{GS} = 10 V$	-	15	-	ns
t _{d(off)}	Turn-off delay time	(see Figure 13. Switching times test circuit for resistive load and	-	100	-	ns
t _f	Fall time	Figure 18. Switching time waveform)	-	11	-	ns

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Table 7. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		-		62	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		220	Α
V _{SD} ⁽²⁾	Forward on voltage	V _{GS} = 0 V, I _{SD} = 62 A	-		1.6	V
t _{rr}	Reverse recovery time	I _{SD} = 62 A, di/dt = 100 A/μs,	-	138	-	ns
Q _{rr}	Reverse recovery charge	V _{DD} = 60 V	-	0.69	-	μC
I _{RRM}	Reverse recovery current	(see Figure 15. Test circuit for inductive load switching and diode recovery times)	-	10	-	Α
t _{rr}	Reverse recovery time	I _{SD} = 62 A, di/dt = 100 A/μs,	-	340	-	ns
Q _{rr}	Reverse recovery charge	V _{DD} = 60 V, T _J = 150 °C	-	4.6	_	μC
I _{RRM}	Reverse recovery current	(see Figure 15. Test circuit for inductive load switching and diode recovery times)	-	27	-	Α

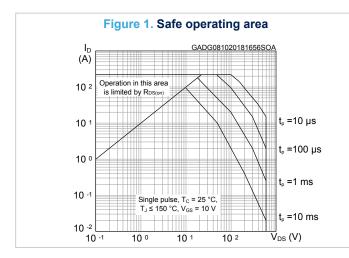
^{1.} Pulse width is limited by safe operating area.

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^{2.} Pulsed: pulse duration = $300 \mu s$, duty cycle 1.5%.



2.1 Electrical characteristics (curves)



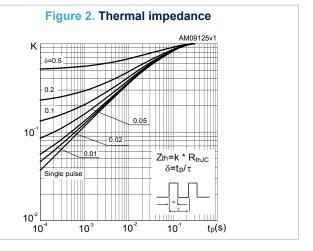


Figure 3. Output characteristics

GADGO810201816550CH

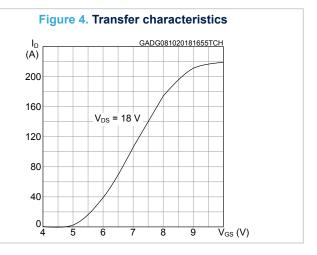
VGS = 9, 10 V

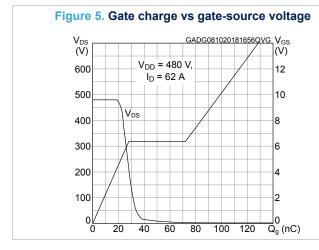
VGS = 8 V

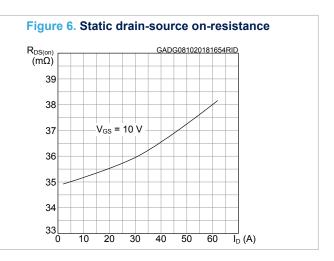
VGS = 7 V

VGS = 6 V

VGS = 5 V







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10 -1

10 º

Figure 7. Capacitance variations

C
(pF)

10 4

10 2

f = 1 MHz

Coss

Coss

10 ¹

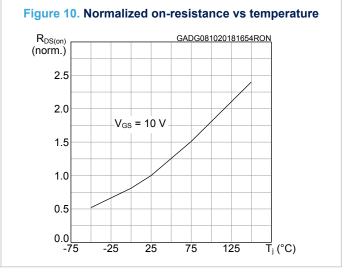
10²

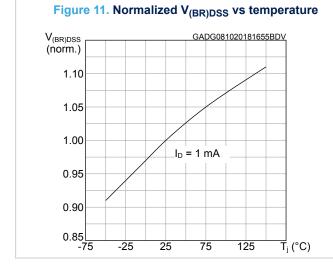
 $\overline{\mathsf{V}}_{\mathsf{DS}}\left(\mathsf{V}\right)$

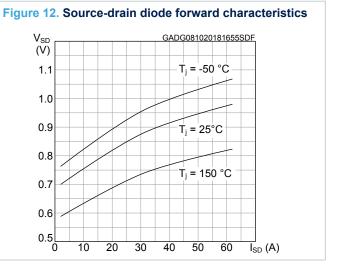
Figure 8. Coss stored energy vs V_{DS}

E
(µJ)
40
32
24
16
8
0
100 200 300 400 500 600 V_{DS} (V)

Figure 9. Normalized gate threshold voltage vs temperature $V_{GS(th)}$ (norm.) GADG081020181654VTH 1.1 1.0 0.9 $I_D = 250 \, \mu A$ 0.8 0.7 0.6 -75 -25 25 75 125 T_j (°C)







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3 Test circuits

Figure 13. Switching times test circuit for resistive load

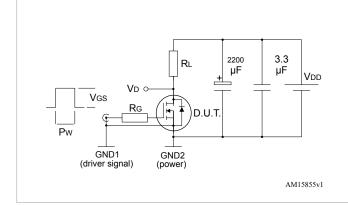


Figure 14. Test circuit for gate charge behavior

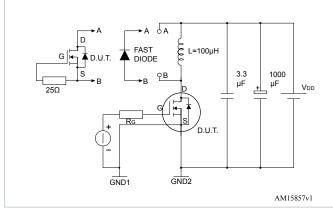
V_{GS}

GND1

GND2

GADG180720181011SA

Figure 15. Test circuit for inductive load switching and diode recovery times



VD 0 2200 3.3 µF VDD

Figure 16. Unclamped inductive load test circuit

Pw GND1 GND2 AM15858v1

Figure 17. Unclamped inductive waveform

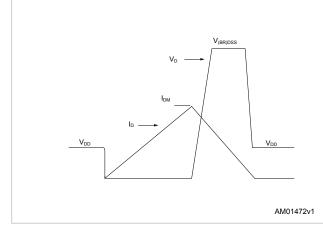
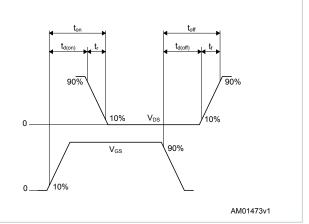


Figure 18. Switching time waveform



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4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

4.1 TO247-4 package information

Α2 \Box D3 øP2 E1 Α1 b2 b (x4) e(x2)SECTION A-A BASE METAL WITH PLATING b1

Figure 19. TO247-4 package outline

8405626_Rev_3

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Table 8. TO247-4 mechanical data

Dim.		mm	
Dim.	Min.	Тур.	Max.
А	4.90	5.00	5.10
A1	2.31	2.41	2.51
A2	1.90	2.00	2.10
b	1.16		1.29
b1	1.15	1.20	1.25
b2	0		0.20
С	0.59		0.66
c1	0.58	0.60	0.62
D	20.90	21.00	21.10
D1	16.25	16.55	16.85
D2	1.05	1.20	1.35
D3	24.97	25.12	25.27
E	15.70	15.80	15.90
E1	13.10	13.30	13.50
E2	4.90	5.00	5.10
E3	2.40	2.50	2.60
е	2.44	2.54	2.64
e1	4.98	5.08	5.18
L	19.80	19.92	20.10
Р	3.50	3.60	3.70
P1			7.40
P2	2.40	2.50	2.60
Q	5.60		6.00
S		6.15	
Т	9.80		10.20
U	6.00		6.40
aaa		0.04	0.10

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Revision history

Table 9. Document revision history

Date	Revision	Changes
16-Apr-2019	1	First release.
06-Jul-2020	2	Updated Table 1. Absolute maximum ratings.
06-Jul-2020	2	Updated Table 7. Source drain diode.
	Updated 0	Updated Table 4. On/off states.
13-Mar-2023		Updated Coss eq. on Table 5. Dynamic characteristics.
13-Wai-2023		Updated Section 4 Package information.
		Minor text changes.

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